

STC08DE150

HYBRID EMITTER SWITCHED BIPOLAR TRANSISTOR ESBT $^{\text{TM}}$ 1500 V - 8 A - 0.075 Ω

PRELIMINARY DATA

Table 1: General Features

V _{CS(ON)}	Ic	R _{CS(ON)}
0.6 V	8 A	0.075 Ω

- n LOW EQUIVALENT ON RESISTANCE
- n VERY FAST-SWITCH, UP TO 150 kHz
- n SQUARED RBSOA, UP TO 1500 V
- $_{ ext{n}}$ VERY LOW C_{ISS} DRIVEN BY RG = 47 Ω

APPLICATION

SINGLE SWITCH SMPS BASED ON THREE PHASE MAINS

DESCRIPTION

The STC08DE150 is manufactured in a hybrid structure, using dedicated high voltage Bipolar and low voltage MOSFET technologies, aimed at providing the best performance in ESBT topology. The STC08DE150 is designed for use in aux flyback smps for any three phase application.

Figure 1: Package

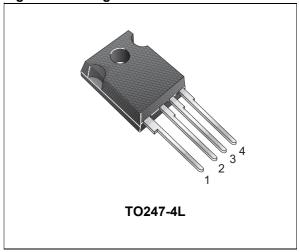


Figure 2: Internal Schematic Diagram

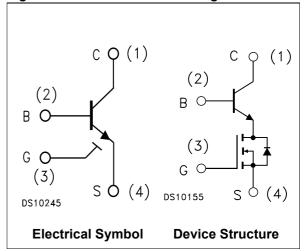


Table 2: Order Code

Part Number	Marking	Package	Packaging	
STC08DE150	C08DE150	TO247-4L	TUBE	

Rev. 1 January 2005

Table 3: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{CS(SS)}	Collector-Source Voltage (V _{BS} = V _{GS} = 0 V)	1500	V
V _{BS(OS)}	Base-Source Voltage (I _C = 0, V _{GS} = 0 V)	30	V
V _{SB(OS)}	Source-Base Voltage (I _C = 0, V _{GS} = 0 V)	9	V
V_{GS}	Gate-Source Voltage	± 20	V
I _C	Collector Current	8	А
I _{CM}	Collector Peak Current (t _p < 5ms)	15	А
Ι _Β	Base Current	4	А
I _{BM}	Base Peak Current (t _p < 1ms)	8	А
P _{tot}	Total Dissipation at T _C = 25 °C	155	W
T _{stg}	Storage Temperature	-65 to 125	°C
TJ	Max. Operating Junction Temperature	125	°C

Table 4: Thermal Data

Symbol	Parameter		Unit
R _{thj-case}	Thermal Resistance Junction-Case Max	0.64	°C/W

Table 5: Electrical Characteristics (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Unit
I _{CS(SS)}	Collector-Source Current (V _{BS} = V _{GS} = 0 V)	V _{CS(SS)} = 1500 V				100	μ A
I _{BS(OS)}	Base-Source Current (I _C = 0 , V _{GS} = 0 V)	V _{BS(OS)} = 30 V				10	μ A
I _{SB(OS)}	Source-Base Current $(I_C = 0, V_{GS} = 0, V)$	V _{SB(OS)} = 9 V				100	μΑ
I _{GS(OS)}	Gate-Source Leakage (V _{BS} = 0 V)	V _{GS} = ±20 V				500	nA
V _{CS(ON)}	Collector-Source ON Voltage	$V_{GS} = 10 \text{ V } I_{C} = 8 \text{ A}$ $V_{GS} = 10 \text{ V } I_{C} = 5 \text{ A}$	5		0.6 0.6	1.4	V V
h _{FE}	DC Current Gain	$I_C = 8 A$ $V_{CS} = 1 V$ $I_C = 5 A$ $V_{CS} = 1 V$		4.5 8	7.5 10		
V _{BS(ON)}	Base-Source ON Voltage	$V_{GS} = 10 \text{ V} I_{C} = 8 \text{ A}$ $V_{GS} = 10 \text{ V} I_{C} = 5 \text{ A}$	I _B = 1.6 A I _B = 0.5 A		1.5 1	2	V V
V _{GS(th)}	Gate Threshold Voltage	$V_{BS} = V_{GS}$	I _B = 250 μA	1.5	2.2	3	V
C _{iss}	Input Capacitance	V _{CS} = 25 V f = 1 MHz	$V_{GS} = V_{CB} = 0$		750		pF
Q _{GS(tot)}	Gate-Source Charge	I _C = 8 A V _{CS} = 25 V	V _{GS} = 10 V V _{CB} = 0		12.5		nC
	INDUCTIVE LOAD	V _{GS} = 10 V	$R_G = 47 \Omega$				
t_s	Storage Time	V _{Clamp} = 1200 V	$t_p = 4 \mu s$		526		ns
t _f	Fall Time	I _C = 5 A	I _B = 0.5 A		8.5		ns
V _{CSW}	Maximum Collector-Source Voltage Switched Without Snubber	$R_G = 47 \Omega$ $h_{FE} = 5$	I _C = 8 A	15			V

Symbol	Parameter	Test Conditi	ons	Min.	Тур.	Max.	Unit
V _{CS(dyn)}	Collector-Source Dynamic Voltage (500 ns)	$V_{CC} = V_{Clamp} = 300 \text{ V}$ $R_G = 47 \Omega$ $I_B = 0.8 \text{ A}$ $I_{Bpeak} = 8 \text{ A } (2 \text{ I}_C)$	$V_{GS} = 10 \text{ V}$ $I_C = 4 \text{ A}$ $t_{peak} = 500 \text{ ns}$		6		V
V _{CS(dyn)}	Voltage	$V_{CC} = V_{Clamp} = 300 \text{ V}$ $R_G = 47 \Omega$ $I_B = 0.8 \text{ A}$ $I_{Bpeak} = 8 \text{ A } (2 \text{ I}_C)$	$V_{GS} = 10 \text{ V}$ $I_C = 4 \text{ A}$ $t_{peak} = 500 \text{ ns}$		2.2		V

Figure 3: Output Characteristics

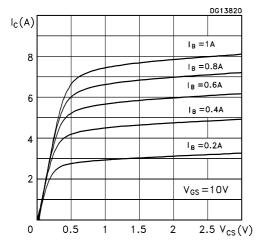


Figure 4: Reverse Biased Safe Operating Area

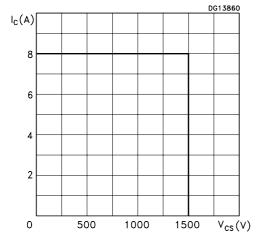


Figure 5: DC Current Gain

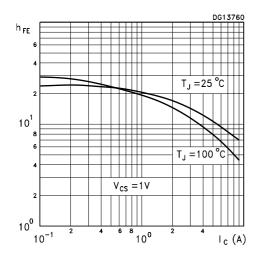


Figure 6: Dynamic Collector-Emitter Saturation Voltage

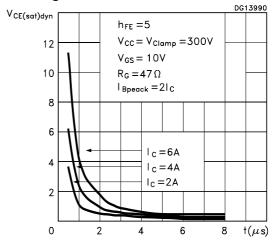


Figure 7: Gate Threshold Voltage vs Temperature

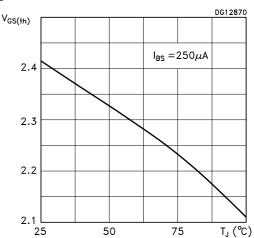


Figure 8: Collector-Source On Voltage

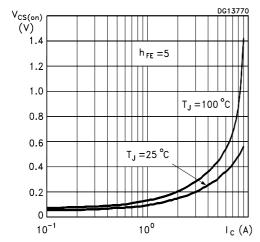


Figure 9: Base-Source On Voltage

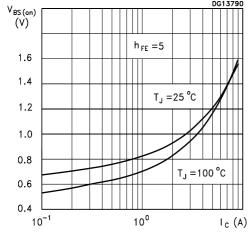


Figure 10: Inductive Load Switching Time

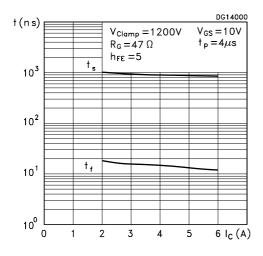


Figure 11: Collector-Source On Voltage

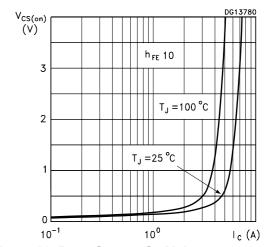


Figure 12: Base-Source On Voltage

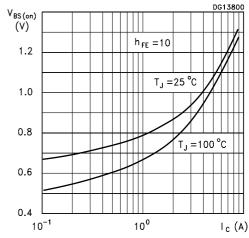
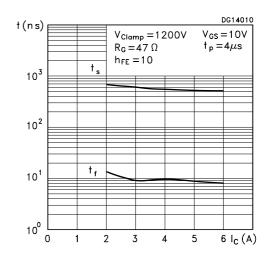


Figure 13: Inductive Load Switching Time



A7/.

Figure 14: Enlargement FBSOA Circuit

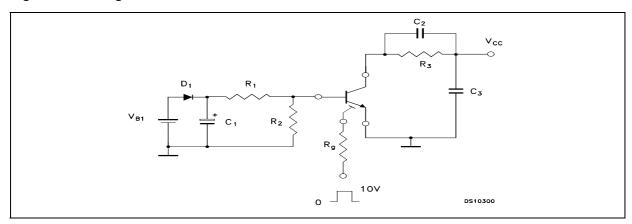
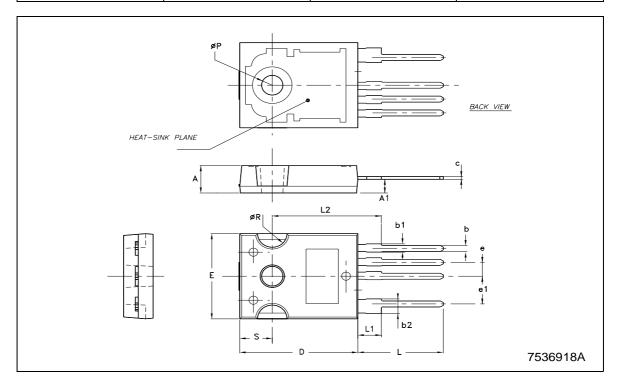


Table 6: Components, Values

V _{B1} = 4.16 V	C ₁ = 4700 µF
D ₁ = BA157	$C_2 \leq 1000 \text{ pF}$
$R_1 = 1 \Omega$	V _{CC} = 1500 V
$R_2 = 100 \Omega$	V _g = 10 V
$R_3 = 180 \Omega$	Pulse Time = 5 μs
R_g = 47 Ω	

TO247-4L MECHANICAL DATA

DIM.	mm			
DIWI.	MIN.	TYP.	MAX.	
А	4.85		5.15	
A1	2.20		2.60	
b	0.95	1.10	1.30	
b1	1.30		1.70	
b2	2.50		2.90	
С	0.40		0.80	
D	19.85		20.15	
Е	15.45		15.75	
е		2.54		
e1		5.08		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S		5.50		



STC08DE150

Table 7: Revision History

Date	Release	Change Designator
20-Jan-2005	1	First Release.

STC08DE150

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